

SI488

"Insulation wafer - silicone (Glass fibre reinforced)
facilitate in combination with insulation bushes insulated mounting of
semiconductors, e.g. to heatsinks.
They are highly flexible and ensure optimal heat conductivity even without
using thermal compounds. "

product features

For device:	TO 220
Dielectriccoefficient	2,56 at 1MHz
Minimum thermal resistance	1,5 K/W
Thickness [mm]	0,18
Device mounted by:	Screw On
Material	Silikon m. Glasfaser
Electrical insulating	2,5 kV

